

### **Technical Data Sheet**

# 1.8mm Round Subminiature Chip LED

#### 42-21USRC/S530-XX/TR8

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mulit-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

#### **Descriptions**

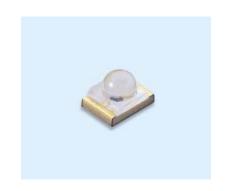
- The 42-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

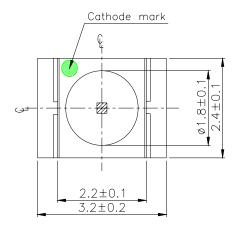
Material Emitted Color		Lens Color
AlGaInP	Dark- Red	Water Clear

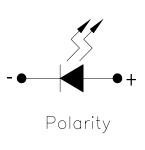


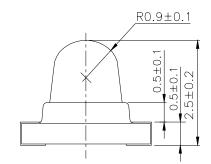
http://www.everlight.com

Prepared by: Ashley Kuo

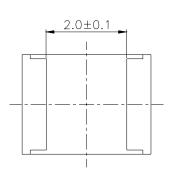
### **Package Outline Dimensions**

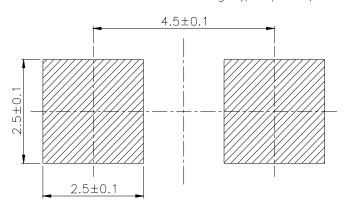






For reflow soldering (propose)





**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 2 of 10

Device No.: DSE-421- Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo



# Absolute Maximum Ratings (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	$V_R$	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 <b>~</b> +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	260 (for 5 second)	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge (HBM)	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IF	60	mA	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec.  Hand Soldering: 350 °C for 3 sec.		

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 3 of 10

Device No. : DSE-421- Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo



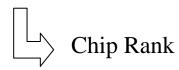
# EVERLIGHT ELECTRONICS CO.,LTD.

### 42-21USRC/S530-XX/TR8

# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	*Chip Min.	Tun	Max.	Unit	Condition	
	Symbol	Rank	IVIIII.	Тур.	Max.	UIII	Condition
		A2	114	302			
		A3	286	459			
Luminous Intensity	IV	A4	343	573		mcd	
		A5	457	742			
		A6	571	913			
Viewing Angle	2 \theta 1/2			30		deg	I <sub>F</sub> =20mA
Peak Wavelength	λp			639		nm	
Dominant Wavelength	λd			631		nm	
Spectrum Radiation Bandwidth	Δλ			20		nm	
Forward Voltage	VF		1.7	2.0	2.4	V	
Reverse Current	Ir				10	$\mu$ A	V <sub>R</sub> =5V

\*42-21USRC/S530<u>-XX</u>/TR8



Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 4 of 10

Device No.: DSE-421- Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo

40°

50°

70°

80° 90°

0.4 0.6

#### **Typical Electro-Optical Characteristics Curves**

30 25

20

10

00

20

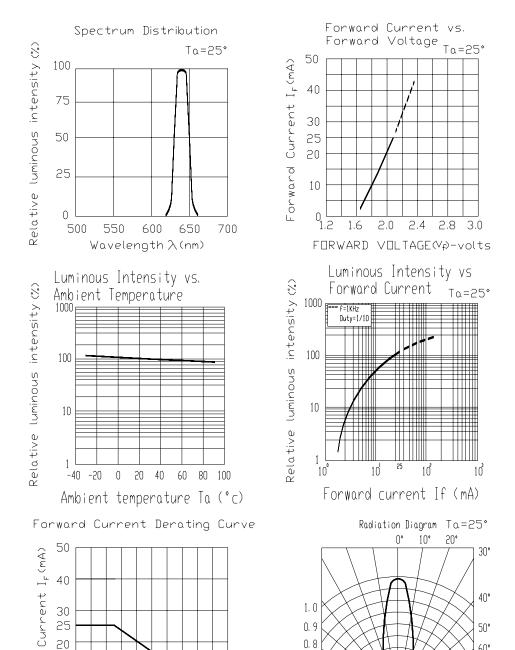
40

60

AMBIENT TEMPERATURE TA (°C)

85

Forward



Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 5 of 10 Device No.: DSE-421-Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo

1.0

0.9

0.8

0.7

0.3

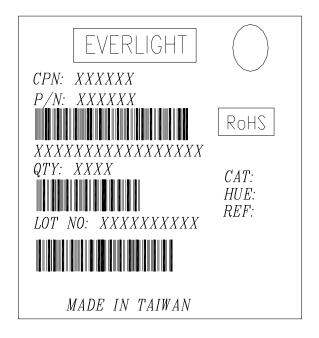
0. 1 0. 2

#### Label explanation

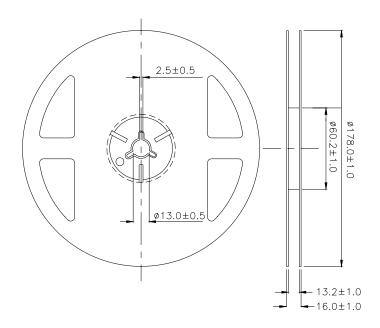
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**

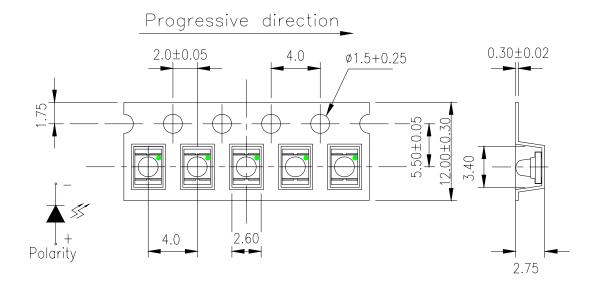


**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 6 of 10

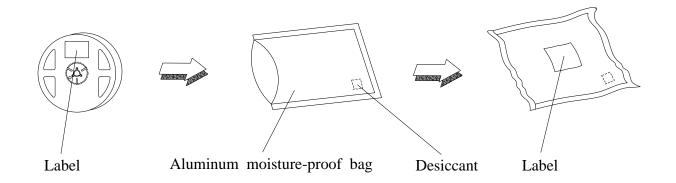
Device No.: DSE-421- Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo

### Carrier Tape Dimensions: Loaded quantity 1000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm.

### **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 7 of 10

Device No.: DSE-421- Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo



# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 8 of 10

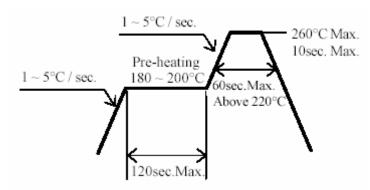
Device No. : DSE-421- Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo

#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.
  - 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 9 of 10

Device No.: DSE-421-Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo

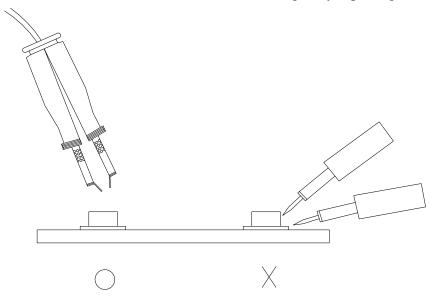


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 10 of 10

Device No.: DSE-421- Prepared date: 16-Aug-2005 Prepared by: Ashley Kuo